

APGA1602QWF/KA-5MAV





DESCRIPTIONS

- The source color devices are made with InGaN on Sapphire-substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 x 0.9 x 0.2 mm right angle SMD LED, 0.2mm thickness
- Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- Tinned pads for improved solderability
- RoHS compliant

APPLICATIONS

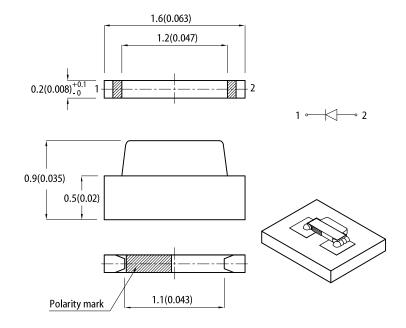
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

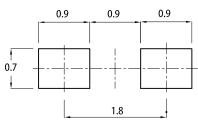


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- All dimensions are in millimeters (inches).
 Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to
- 4. The device has a single mounting surface. The device must be mounted according to the specifications

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
APGA1602QWF/KA-5MAV	White (InGaN)	Yellow Fluorescent	20	60	150°

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit	
Faranietei	Symbol Emitting Color		Тур.	Max.	Offic	
Chromaticity Coordinates x I _F = 5mA	x ^[1]	White	0.31	-		
Chromaticity Coordinates y I _F = 5mA	y ^[1]	White	0.31	-		
Forward Voltage I _F = 5mA	V _F ^[2]	White	2.8	3.2	V	
Reverse Current (V _R = 5V)	I _R	White	-	50	uA	

ABSOLUTE MAXIMUM RATINGS at T₄=25°C

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Parameter	Symbol	Value	Unit		
Power Dissipation	P _D	70	mW		
Reverse Voltage	V_R	5	V		
Junction Temperature	T _j	115	°C		
Operating Temperature	T _{op}	-40 to +85	°C		
Storage Temperature	T _{stg}	-40 to +100	°C		
DC Forward Current	I _F	20	mA		
Peak Forward Current	I _{FM} ^[1]	100	mA		
Electrostatic Discharge Threshold (HBM)	-	250	V		

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

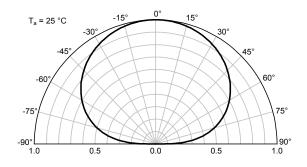


Measurement tolerance of the chromaticity coordinates is ±0.01.
 Forward voltage: ±0.1V.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

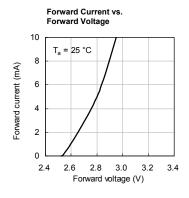


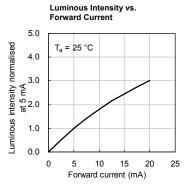
TECHNICAL DATA

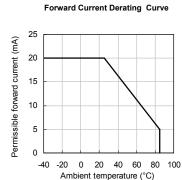
SPATIAL DISTRIBUTION

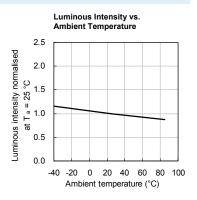


WHITE

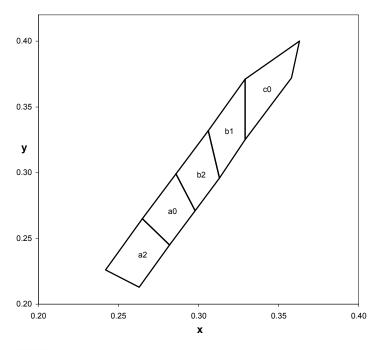








White CIE



	x	у		x	у
a2	0.263	0.213	a0	0.282	0.245
	0.282	0.245		0.298	0.271
	0.265	0.265		0.286	0.299
	0.242	0.226		0.265	0.265
b2	0.298	0.271	b1	0.313	0.296
	0.313	0.296		0.329	0.325
	0.306	0.332		0.329	0.371
	0.286	0.299		0.306	0.332
c0	0.329	0.325			
	0.358	0.372			
	0.363	0.400			
	0.329	0.371			
			•		

Shipment may contain more than one chromaticity regions.

Orders for single chromaticity region are generally not accepted.

Measurement tolerance of the chromaticity coordinates is ±0.01.

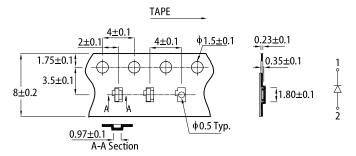




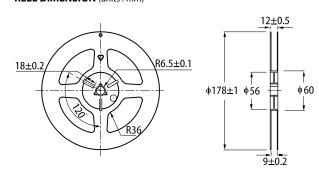
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

300 above 255°C 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max. 200 150 pre-heating 100 150~200°C above 217°C 60~150s 60~120s 50 0 0 50 100 150 200 250 Time

TAPE SPECIFICATIONS (units:mm)



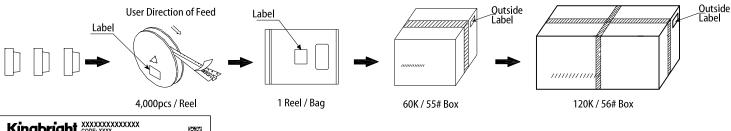
REEL DIMENSION (units: mm)



Notes

- Don't cause stress to the LEDs while it is exposed to high temperature.
- The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

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